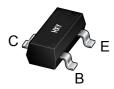


# **FEATURES**

Collector Current: I<sub>C</sub>=0.15A

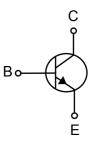
• Power Dissipation of 200mw



**SOT-23** 

# **Package Marking and Ordering Information**

_	_	_	
Product ID	Pack	Marking	Qty(PCS)
2SC1815	SOT-23	HF	3000



# MAXIMUM RATINGS (Ta=25 unless otherwise noted)

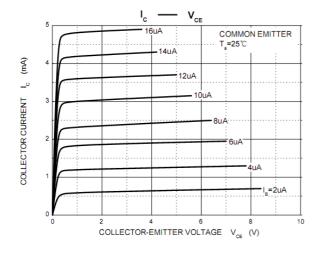
Parameter	Symbol	Limit	Unit
Collector-Base Voltage	V <sub>CBO</sub>	60	V
Collector-Emitter Voltage	V <sub>CEO</sub>	50	V
Emitter-Base Voltage	V <sub>EBO</sub>	5	V
Collector Current	I <sub>c</sub>	150	mA
Collector Power Dissipation	P <sub>c</sub>	200	mW
Thermal Resistance From Junction To Ambient	R <sub>OJA</sub>	625	°CM
Junction Temperature	T <sub>j</sub>	150	${\mathfrak C}$
Storage Temperature	T <sub>stg</sub>	-55∼+150	℃

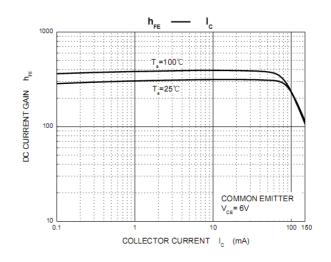


# ELECTRICAL CHARACTERISTICS (Ta=25 unless otherwise specified)

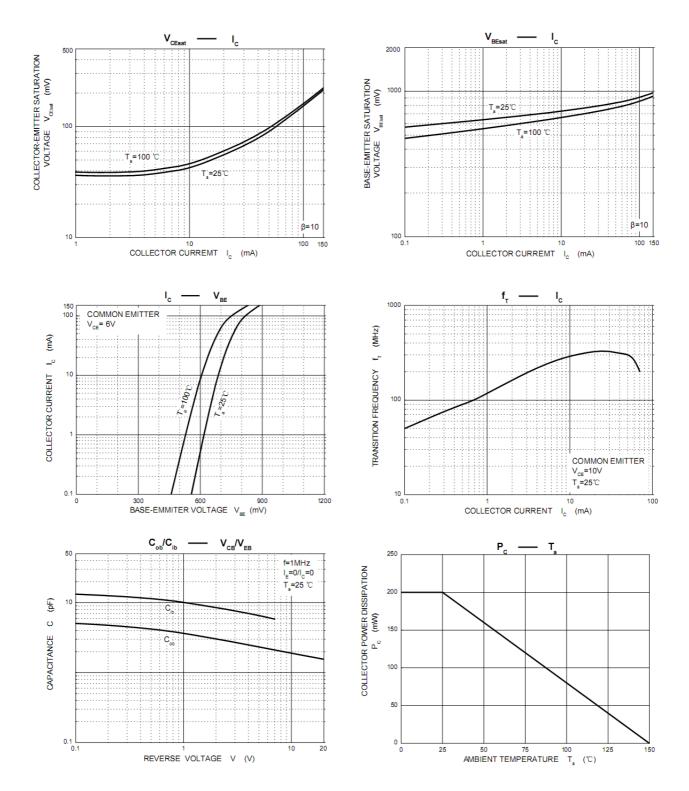
Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> = 100uA, I <sub>E</sub> =0	60			V
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> = 0.1mA, I <sub>B</sub> =0	50			V
Emitter-base breakdown voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> = 100uA, I <sub>C</sub> =0	5			>
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> =60V, I <sub>E</sub> =0			0.1	uA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 5V, I <sub>C</sub> =0			0.1	uA
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = 6V, I <sub>C</sub> = 2mA	130		400	
Collector-emitter saturation voltage	V <sub>CE</sub> (sat)	I <sub>C</sub> =100mA, I <sub>B</sub> = 10mA			0.25	V
Base-emitter saturation voltage	V <sub>BE</sub> (sat)	I <sub>C</sub> =100mA, I <sub>B</sub> = 10mA			1	V
Transition frequency	f⊤	$V_{CE}$ =10V, $I_{C}$ = 1mA, $f$ =30MHz	80			MHz

# **Typical Characteristics**



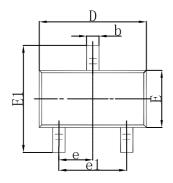


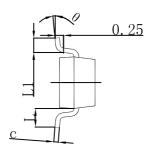


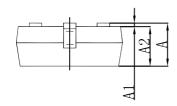




# **SOT-23 Package Outline Dimensions**

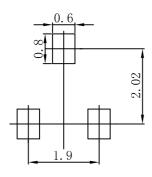






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950	TYP	0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

# **SOT-23 Suggested Pad Layout**



- Note:
  1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
  3.The pad layout is for reference purposes only.



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